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Low Power Electronics - Recent Developments

Guest Editor:

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Deadline for manuscript submissions:

closed (25 December 2011)

Message from the Guest Editor

Dear Colleagues,

This Special Issue is seeking solid papers from authors who contributed papers in Low Power Electronics in recent high quality conferences. Expanded versions of recent conference papers are welcome, but only when significant details have been added. Both research articles and review articles are invited. The issue is scheduled for publication in March, 2012.

Prof. Dr. Orly Yadid-Pecht

Guest Editor











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Message from the Editor-in-Chief

Journal of Low Power Electronics and Applications (ISSN) 2079-9268) is an open access journal which provides an advanced forum for the studies of electronics for low power applications. A special emphasize is made on ultralow power bio-medical applications. It publishes regular reviews. research papers and short communications

Our aim is to encourage scientists to publish their experimental and theoretical results in as much detail as possible. There is no restriction on the length of the papers. Full experimental and/or methodical details must be provided.

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